



# PESD5V0U2BT

Ultra low capacitance bidirectional double ESD protection diode

Rev. 01 — 27 March 2007

Product data sheet

## 1. Product profile

### 1.1 General description

Ultra low capacitance bidirectional double ElectroStatic Discharge (ESD) protection diode in a SOT23 (TO-236AB) small Surface-Mounted Device (SMD) plastic package designed to protect two data lines from the damage caused by ESD.

### 1.2 Features

- Bidirectional ESD protection of two lines
- Ultra low leakage current:  $I_{RM} = 5 \text{ nA}$
- Ultra low diode capacitance:  $C_d = 2.9 \text{ pF}$
- ESD protection of up to 10 kV
- IEC 61000-4-2; level 4 (ESD)

### 1.3 Applications

- Computers and peripherals
- Audio and video equipment
- Cellular handsets and accessories
- 10/100/1000 Ethernet
- Local Area Network (LAN) equipment
- Communication systems
- Portable electronics
- Subscriber Identity Module (SIM) card protection
- FireWire
- High-speed data lines

### 1.4 Quick reference data

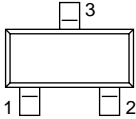
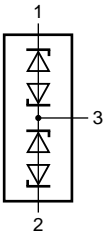
Table 1. Quick reference data

$T_{amb} = 25^\circ\text{C}$  unless otherwise specified.

| Symbol           | Parameter                | Conditions                             | Min | Typ | Max | Unit |
|------------------|--------------------------|--|-----|-----|-----|------|
| <b>Per diode</b> |                          |  |     |     |     |      |
| $V_{RWM}$        | reverse standoff voltage |  | -   | -   | 5   | V    |
| $C_d$            | diode capacitance        | $f = 1 \text{ MHz}; V_R = 0 \text{ V}$ | -   | 2.9 | 3.5 | pF   |

## 2. Pinning information

Table 2. Pinning

| Pin | Description    | Simplified outline  | Symbol  |
|-----|----------------|---|---|
| 1   | cathode 1      |  |  |
| 2   | cathode 2      |   |   |
| 3   | common cathode |   |   |

## 3. Ordering information

Table 3. Ordering information

| Type number | Package |  |         |
|-------------|---------|--|---------|
|             | Name    | Description                              | Version |
| PESD5V0U2BT | -       | plastic surface-mounted package; 3 leads | SOT23   |

## 4. Marking

Table 4. Marking codes

| Type number | Marking code <sup>[1]</sup> |
|-------------|-----------------------------|
| PESD5V0U2BT | 1U*                         |

- [1] \* = -: made in Hong Kong  
 \* = p: made in Hong Kong  
 \* = t: made in Malaysia  
 \* = W: made in China

## 5. Limiting values

**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol            | Parameter            | Conditions | Min | Max  | Unit |
|-------------------|----------------------|------------|-----|------|------|
| <b>Per device</b> |                      |            |     |      |      |
| $T_j$             | junction temperature |            | -   | 150  | °C   |
| $T_{amb}$         | ambient temperature  |            | -65 | +150 | °C   |
| $T_{stg}$         | storage temperature  |            | -65 | +150 | °C   |

**Table 6. ESD maximum ratings**

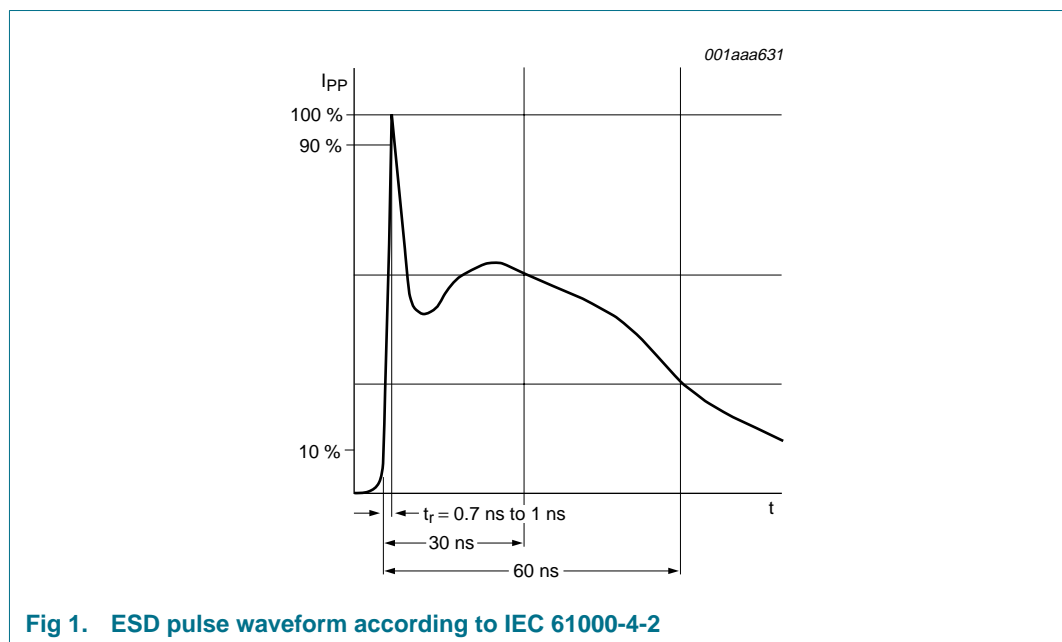
| Symbol           | Parameter                       | Conditions                        | Min    | Max | Unit |
|------------------|---------------------------------|-----------------------------------|--------|-----|------|
| <b>Per diode</b> |                                 |                                   |        |     |      |
| $V_{ESD}$        | electrostatic discharge voltage | IEC 61000-4-2 (contact discharge) | [1][2] | 10  | kV   |
|                  |                                 | MIL-STD-883 (human body model)    | -      | 8   | kV   |

[1] Device stressed with ten non-repetitive ESD pulses.

[2] Measured from pin 1 to pin 2.

**Table 7. ESD standards compliance**

| Standard                                | Conditions                      |
|---|---------------------------------|
| <b>Per diode</b>                        |                                 |
| IEC 61000-4-2; level 4 (ESD)            | > 15 kV (air); > 8 kV (contact) |
| MIL-STD-883; class 3 (human body model) | > 4 kV                          |



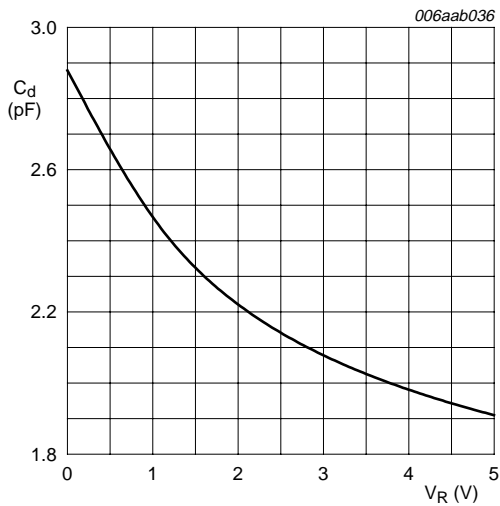
**Fig 1. ESD pulse waveform according to IEC 61000-4-2**

## 6. Characteristics

**Table 8. Characteristics**

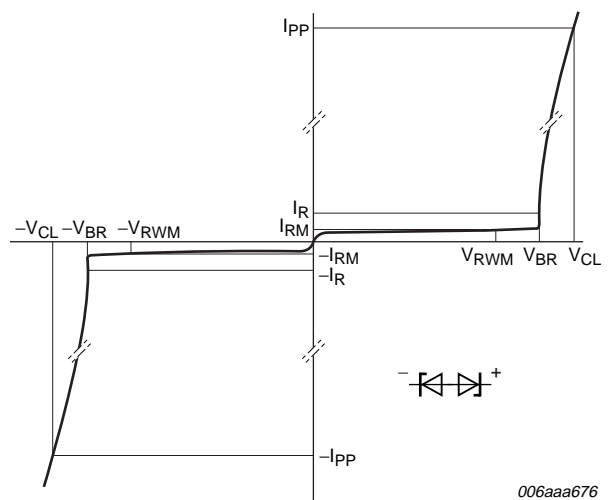
$T_{amb} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified.

| Symbol           | Parameter                | Conditions             | Min | Typ | Max | Unit     |
|------------------|--------------------------|------------------------|-----|-----|-----|----------|
| <b>Per diode</b> |                          |                        |     |     |     |          |
| $V_{RWM}$        | reverse standoff voltage |                        | -   | -   | 5   | V        |
| $I_{RM}$         | reverse leakage current  | $V_{RWM} = 5\text{ V}$ | -   | 5   | 100 | nA       |
| $V_{BR}$         | breakdown voltage        | $I_R = 5\text{ mA}$    | 5.5 | 7   | 9.5 | V        |
| $C_d$            | diode capacitance        | $f = 1\text{ MHz}$     |     |     |     |          |
|                  |                          | $V_R = 0\text{ V}$     | -   | 2.9 | 3.5 | pF       |
|                  |                          | $V_R = 5\text{ V}$     | -   | 1.9 | -   | pF       |
| $r_{dif}$        | differential resistance  | $I_R = 1\text{ mA}$    | -   | -   | 100 | $\Omega$ |



$f = 1\text{ MHz}; T_{amb} = 25\text{ }^{\circ}\text{C}$

**Fig 2. Diode capacitance as a function of reverse voltage; typical values**



**Fig 3. V-I characteristics for a bidirectional ESD protection diode**

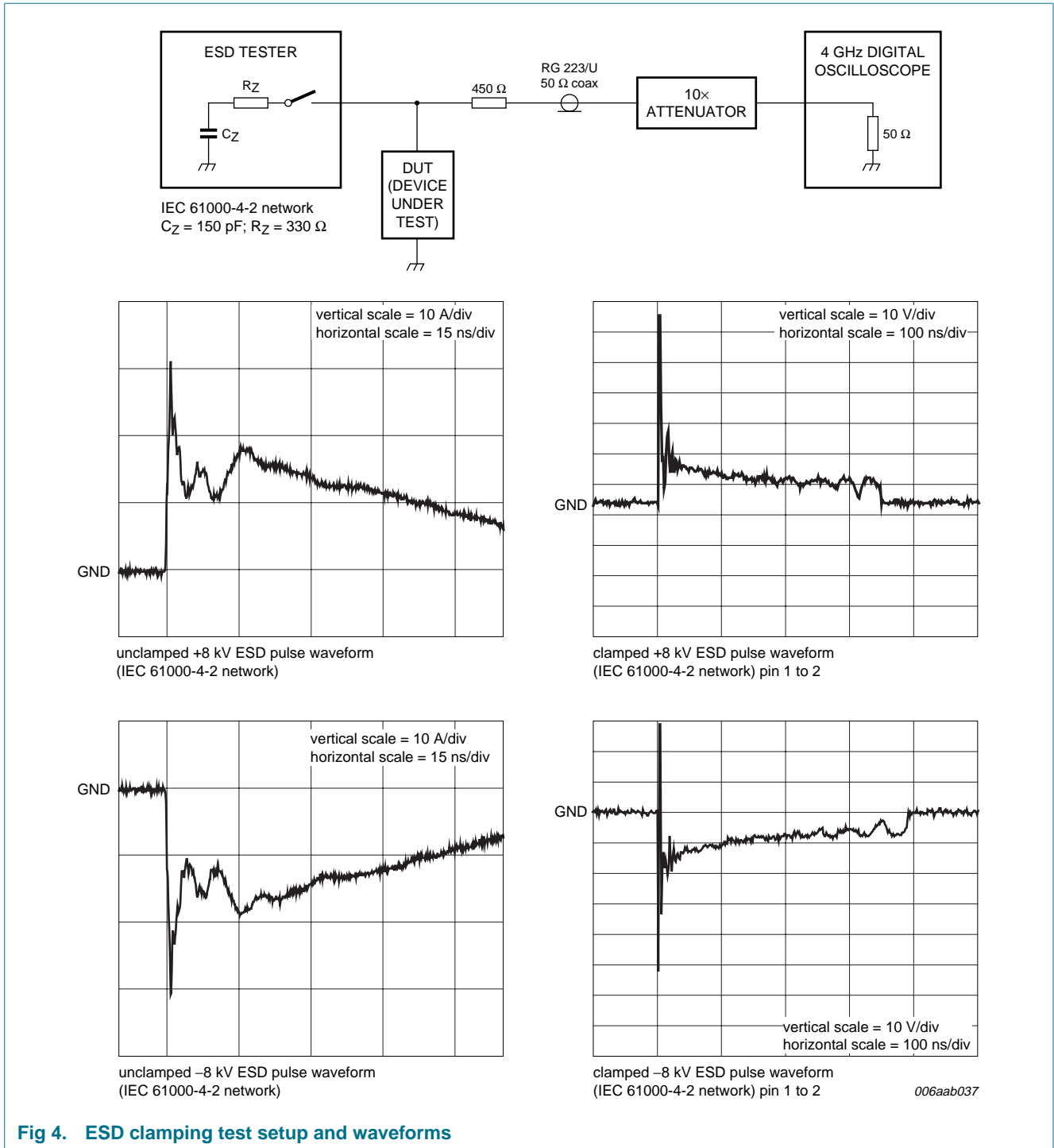


Fig 4. ESD clamping test setup and waveforms

## 7. Application information

The PESD5V0U2BT is designed for the bidirectional protection of two signal lines from the damage caused by ESD pulses. The PESD5V0U2BT may be used on lines where the signal polarities are either positive or negative with respect to ground.

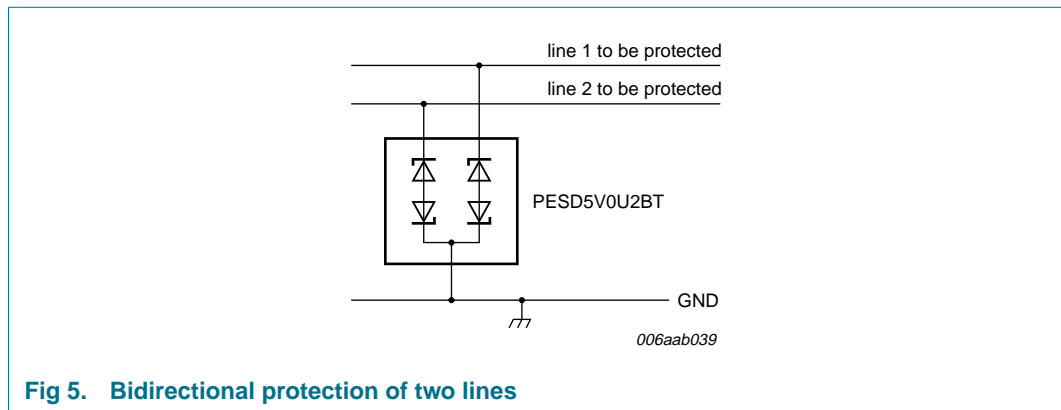


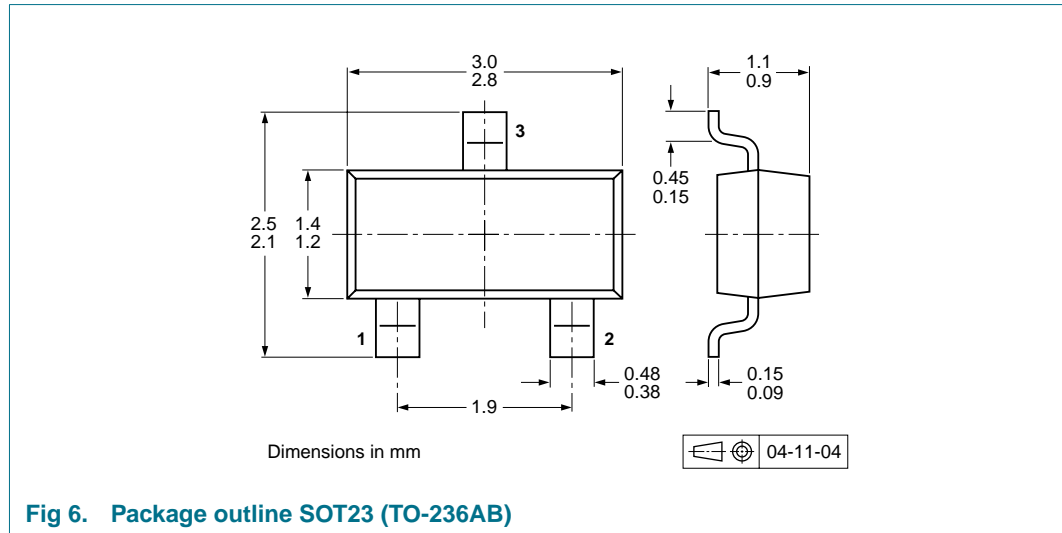
Fig 5. Bidirectional protection of two lines

### Circuit board layout and protection device placement

Circuit board layout is critical for the suppression of ESD, Electrical Fast Transient (EFT) and surge transients. The following guidelines are recommended:

1. Place the PESD5V0U2BT as close to the input terminal or connector as possible.
2. The path length between the PESD5V0U2BT and the protected line should be minimized.
3. Keep parallel signal paths to a minimum.
4. Avoid running protected conductors in parallel with unprotected conductors.
5. Minimize all Printed-Circuit Board (PCB) conductive loops including power and ground loops.
6. Minimize the length of the transient return path to ground.
7. Avoid using shared transient return paths to a common ground point.
8. Ground planes should be used whenever possible. For multilayer PCBs, use ground vias.

## 8. Package outline



## 9. Packing information

**Table 9. Packing methods**

The indicated -xxx are the last three digits of the 12NC ordering code.<sup>[1]</sup>

| Type number | Package | Description                    | Packing quantity |       |
|-------------|---------|--------------------------------|------------------|-------|
|             |         |                                | 3000             | 10000 |
| PESD5V0U2BT | SOT23   | 4 mm pitch, 8 mm tape and reel | -215             | -235  |

[1] For further information and the availability of packing methods, see [Section 13](#).

10. Soldering

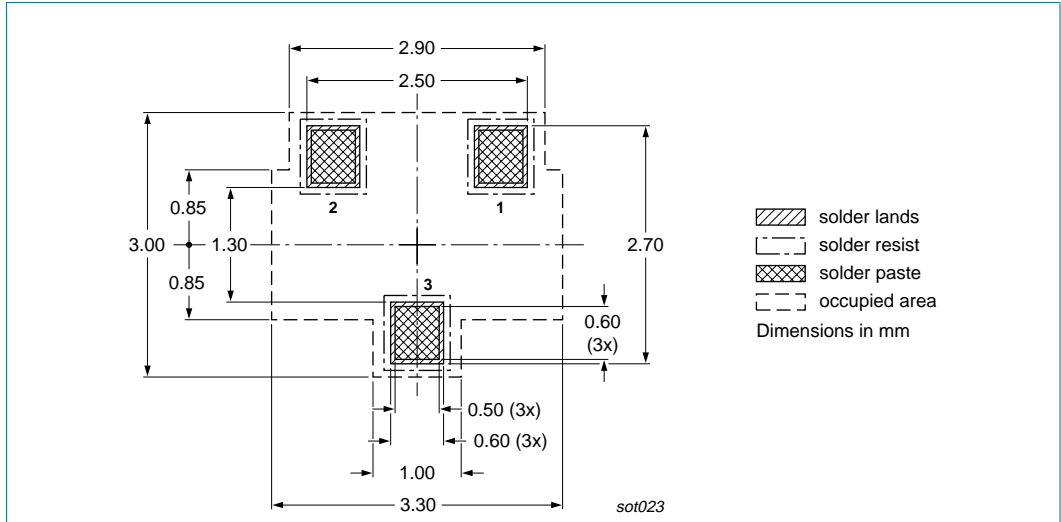


Fig 7. Reflow soldering footprint SOT23 (TO-236AB)

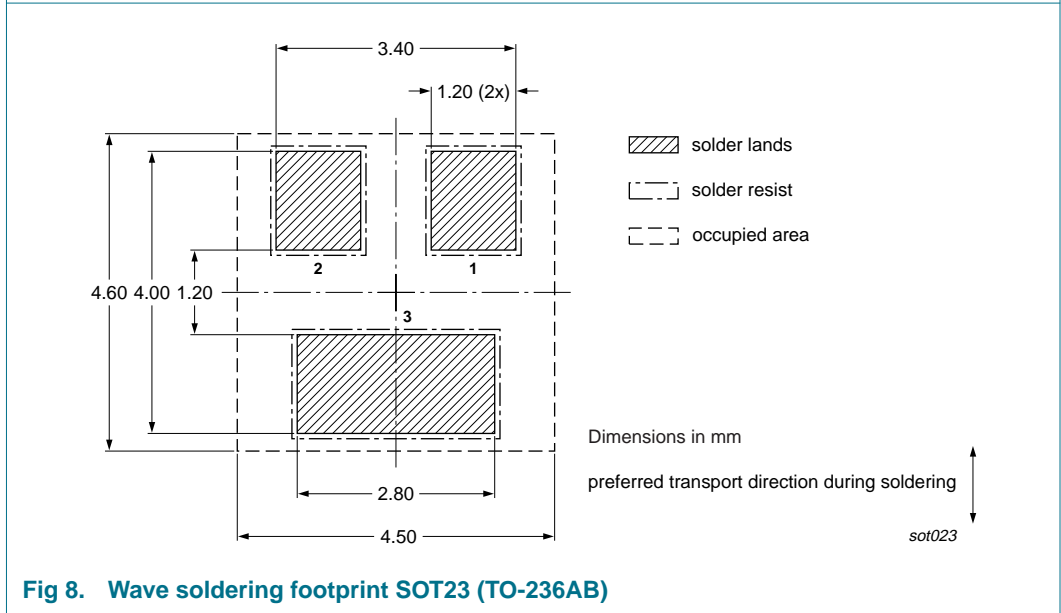


Fig 8. Wave soldering footprint SOT23 (TO-236AB)



## 11. Revision history

Table 10. Revision history

| Document ID   | Release date | Data sheet status  | Change notice | Supersedes |
|---------------|--------------|--------------------|---------------|------------|
| PESD5V0U2BT_1 | 20070327     | Product data sheet | -             | -          |

## 12. Legal information

### 12.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

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